

FMMTA42TC Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	FMMTA42TC-DG
Manufacturer	Diodes Incorporated
Manufacturer Product Number	FMMTA42TC
Description	TRANS NPN 300V 0.2A SOT23-3
Detailed Description	Bipolar (BJT) Transistor NPN 300 V 200 mA 50MHz 3 30 mW Surface Mount SOT-23-3



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Purchase and inquiry

Manufacturer Product Number:

FMMTA42TC

Series:

-

Transistor Type:

NPN

Voltage - Collector Emitter Breakdown (Max):

300 V

Current - Collector Cutoff (Max):

100nA (ICBO)

Power - Max:

330 mW

Operating Temperature:

-55°C ~ 150°C (TJ)

Package / Case:

TO-236-3, SC-59, SOT-23-3

Base Product Number:

FMMTA42

Manufacturer:

Diodes Incorporated

Product Status:

Obsolete

Current - Collector (Ic) (Max):

200 mA

Vce Saturation (Max) @ Ib, Ic:

500mV @ 2mA, 20mA

DC Current Gain (hFE) (Min) @ Ic, Vce:

40 @ 30mA, 10V

Frequency - Transition:

50MHz

Mounting Type:

Surface Mount

Supplier Device Package:

SOT-23-3

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



FMMTA42

300V NPN HIGH VOLTAGE TRANSISTOR IN SOT23

Features

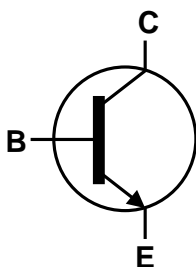
- $BV_{CEO} > 300V$
- $I_C = 200mA$ High Collector Current
- 350mW Power Dissipation
- Excellent h_{FE} Characteristics up to 30mA
- Complementary Part Number FMMTA92
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **An automotive-compliant part is available under separate datasheet (FMMTA42Q)**

Mechanical Data

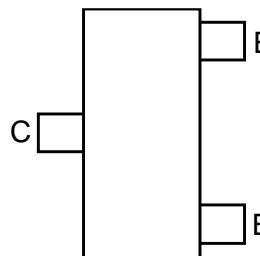
- Package: SOT23
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 **e3**
- Weight: 0.008 grams (Approximate)



Top View



Device Symbol



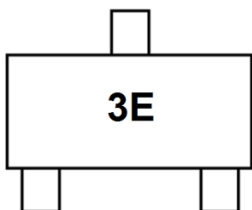
Top View Pin-Out

Ordering Information (Note 4)

Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
FMMTA42TA	SOT23	3E	7	8	3,000	Reel
FMMTA42TC	SOT23	3E	13	8	10,000	Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



3E = Product Type Marking Code


Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	300	V
Collector-Emitter Voltage	V _{CEO}	300	V
Emitter-Base Voltage	V _{EBO}	7	V
Collector Current	I _C	200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	(Note 5) 310	mW
		(Note 6) 350	
Thermal Resistance, Junction to Ambient	R _{θJA}	(Note 5) 403	°C/W
		(Note 6) 357	
Thermal Resistance, Junction to Leads	R _{θJL}	350	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition.
 6. Same as Note 5, except the device is mounted on 15mm x 15mm 1oz copper.
 7. Thermal resistance from junction to solder-point (at the end of the leads).
 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

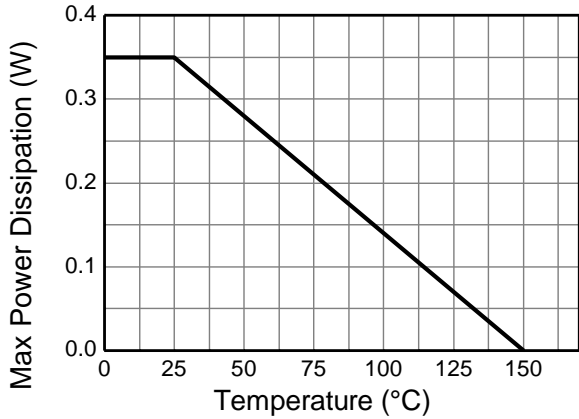


Figure 1. Derating Curve

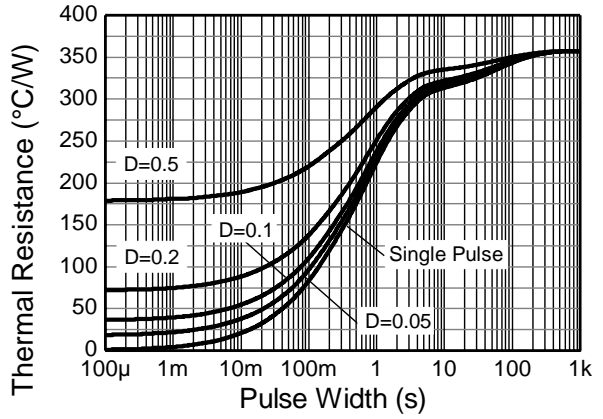


Figure 2. Transient Thermal Impedance

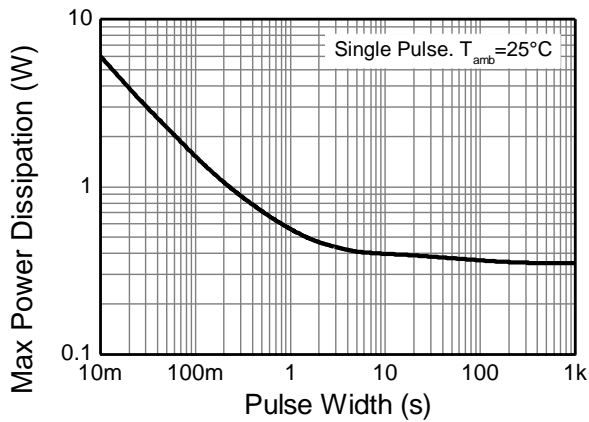


Figure 3. Pulse Power Dissipation

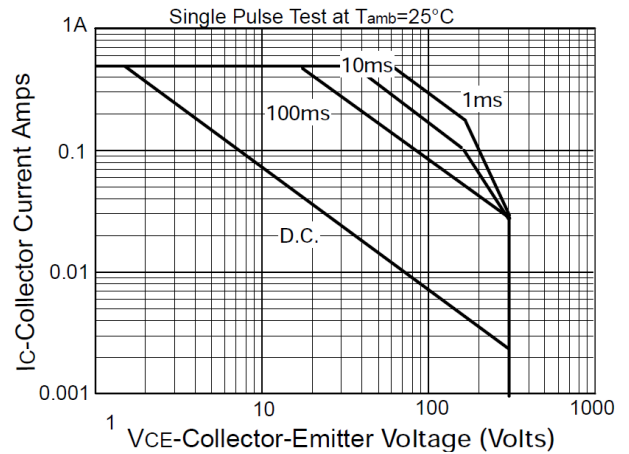


Figure 4. Safe Operating Area



FMMTA42

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CB0}	300	—	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	300	—	—	V	I _C = 1mA
Emitter-Base Breakdown Voltage	BV _{EB0}	7	—	—	V	I _E = 100μA
Collector Cutoff Current	I _{CES}	—	—	100	nA	V _{CE} = 200V
Collector Cutoff Current	I _{CB0}	—	—	100	nA	V _{CB} = 200V
Emitter Cutoff Current	I _{EBO}	—	—	100	nA	V _{EB} = 6V
Static Forward Current Transfer Ratio (Note 9)	h _{FE}	25 40 40	—	—	—	I _C = 1mA, V _{CE} = 10V I _C = 10mA, V _{CE} = 10V I _C = 30mA, V _{CE} = 10V
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(sat)}	—	—	500	mV	I _C = 20mA, I _B = 2mA
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	—	—	900	mV	I _C = 20mA, I _B = 2mA
Output Capacitance	C _{obo}	—	—	6	pF	V _{CB} = 20V, f = 1MHz
Transition Frequency	f _T	50	—	—	MHz	V _{CE} = 20V, I _C = 10mA f = 20MHz

Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

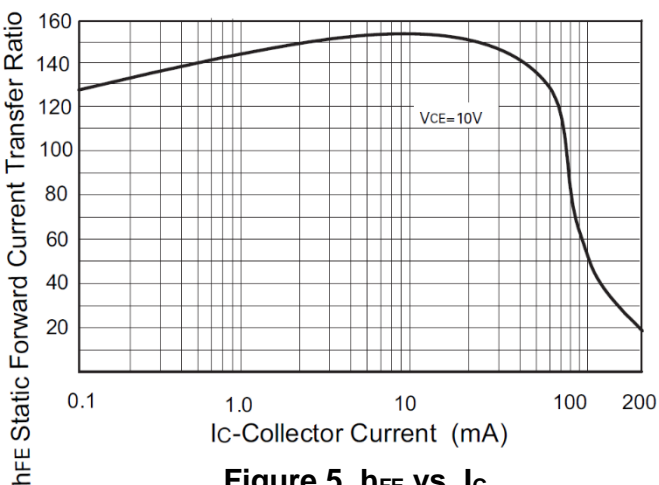


Figure 5. h_{FE} vs. I_C

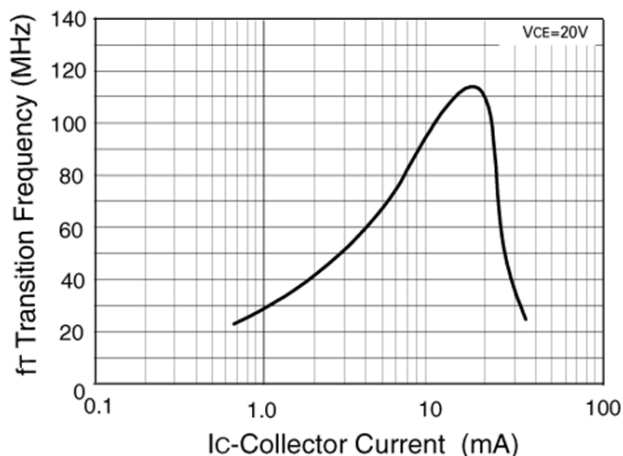


Figure 6. f_T vs. I_C

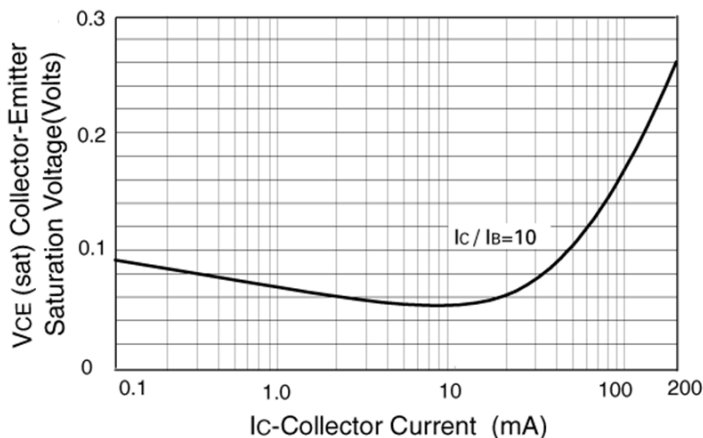
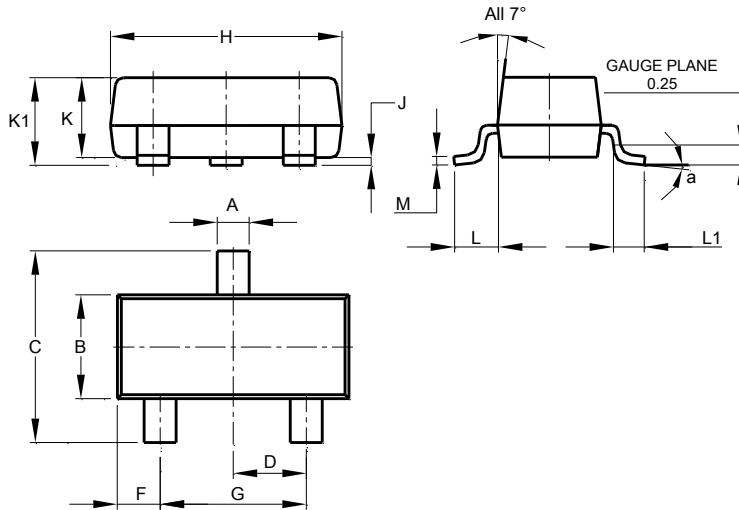


Figure 7. V_{CE(sat)} vs. I_C

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

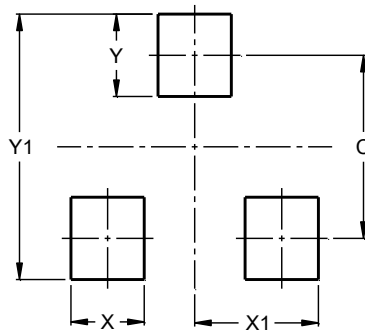


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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